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THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Ronald Patrick Huemoeller, et al.
Assignee: Amkor Technology, Inc.
Title: INTEGRATED CIRCUIT SUBSTRATE HAVING EMBEDDED LANDS
WITH ETCHING AND PLATING CONTROL SHAPES
Serial No.: 10/701,782 Filed: November 5, 2003
Examiner: Semenenko, Yuriy Group Art Unit: 2841
Docket No.: G0092-7P

Monterey, CA
August 3, 2006

Commissioner for Patents
P.O. Box 1450
Alexandria, VA. 22313-1450

Attention: Office of Initial Patent Examination's Customer
Service Center.

REQUEST FOR CORRECTED FILING RECEIPT

Dear Sir:

Applicant(s) hereby request that the Filing Receipt for
the above-identified patent application be corrected to
correctly recite the Domestic priority data.

This request is supported by the following Exhibits:

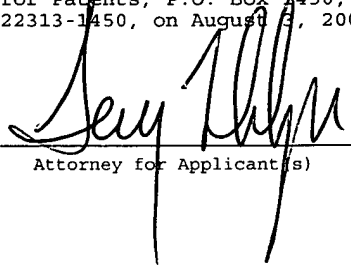
- Exhibit A) A copy of the Preliminary Amendment as filed on
February 12, 2004 setting forth the domestic
priority data;
- Exhibit B) A copy of the USPTO date stamped return
receipt postcard documenting that the
Preliminary Amendment filed on February 12,
2004 was received by the USPTO; and
- Exhibit C) A copy of the Filing Receipt with the change
noted in red.

The Commissioner is hereby authorized to charge any fees which may be required, or credit any overpayment to Deposit Account No. 50-0553.

If a petition is required, Applicant(s) hereby petitions for entry and allowance of this request.

If this request does not lead to issuance of a corrected filing receipt, please contact the undersigned at the number given below.

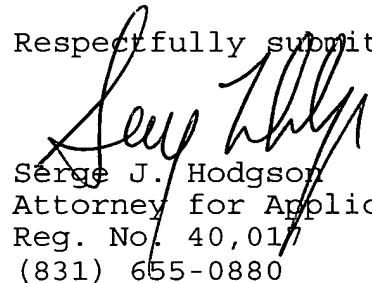
I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage for First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA., 22313-1450, on August 3, 2006



Attorney for Applicant(s)

August 3, 2006
Date of Signature

Respectfully submitted,



Serge J. Hodgson
Attorney for Applicant(s)
Reg. No. 40,017
(831) 655-0880



UNITED STATES PATENT AND TRADEMARK OFFICE

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UNITED STATES DEPARTMENT OF COMMERCE
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APPL NO.	FILING OR 371 (c) DATE	ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
10/701,782	11/05/2003	2827	856	W0308039 G0092-7P	5	20	4

CONFIRMATION NO. 7434

23504
WEISS & MOY PC
4204 NORTH BROWN AVENUE
SCOTTSDALE, AZ 85251

FILING RECEIPT



OC000000011832794

Date Mailed: 02/04/2004

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Filing Receipt Corrections, facsimile number 703-746-9195. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Ronald Patrick Huemoeller, Chandler, AZ;
David Jon Hiner, Chandler, AZ;
Sukianto Rusli, Phoenix, AZ;
Richard Sheridan, Gilbert, AZ;

10-5-04
11-5-04

Domestic Priority data as claimed by applicant

This application is a CIP of 09/931,144 08/16/2001
and is a CIP of 10/138,225 05/01/2002
and is a CIP of 09/931,144 08/16/2001
and is a CIP of 10/261,868 10/01/2002

09/884,193 06/19/2001

Foreign Applications

If Required, Foreign Filing License Granted: 02/04/2004

Projected Publication Date: Request for Non-Publication Acknowledged

Non-Publication Request: Yes

Early Publication Request: No

Title

Exhibit C

9

Integrated circuit substrate having embedded lands with etching and plating control shapes

Preliminary Class

174

**LICENSE FOR FOREIGN FILING UNDER
Title 35, United States Code, Section 184
Title 37, Code of Federal Regulations, 5.11 & 5.15**

GRANTED

The applicant has been granted a license under 35 U.S.C. 184, if the phrase "IF REQUIRED, FOREIGN FILING LICENSE GRANTED" followed by a date appears on this form. Such licenses are issued in all applications where the conditions for issuance of a license have been met, regardless of whether or not a license may be required as set forth in 37 CFR 5.15. The scope and limitations of this license are set forth in 37 CFR 5.15(a) unless an earlier license has been issued under 37 CFR 5.15(b). The license is subject to revocation upon written notification. The date indicated is the effective date of the license, unless an earlier license of similar scope has been granted under 37 CFR 5.13 or 5.14.

This license is to be retained by the licensee and may be used at any time on or after the effective date thereof unless it is revoked. This license is automatically transferred to any related applications(s) filed under 37 CFR 1.53(d). This license is not retroactive.

The grant of a license does not in any way lessen the responsibility of a licensee for the security of the subject matter as imposed by any Government contract or the provisions of existing laws relating to espionage and the national security or the export of technical data. Licensees should apprise themselves of current regulations especially with respect to certain countries, of other agencies, particularly the Office of Defense Trade Controls, Department of State (with respect to Arms, Munitions and Implements of War (22 CFR 121-128)); the Office of Export Administration, Department of Commerce (15 CFR 370.10 (j)); the Office of Foreign Assets Control, Department of Treasury (31 CFR Parts 500+) and the Department of Energy.

NOT GRANTED

No license under 35 U.S.C. 184 has been granted at this time, if the phrase "IF REQUIRED, FOREIGN FILING LICENSE GRANTED" DOES NOT appear on this form. Applicant may still petition for a license under 37 CFR 5.12, if a license is desired before the expiration of 6 months from the filing date of the application. If 6 months has lapsed from the filing date of this application and the licensee has not received any indication of a secrecy order under 35 U.S.C. 181, the licensee may foreign file the application pursuant to 37 CFR 5.15(b).



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT: Huemoeller et al.

DOCKET NO.: W0308039

SERIAL NO: 10/701,782

EXAMINER: Not Assigned

FILED: 11/05/2003

ART UNIT: 2827

TITLE: INTEGRATED CIRCUIT SUBSTRATE HAVING EMBEDDED LANDS WITH
ETCHING AND PLATING CONTROL SHAPES

Mail Stop Non-Fee Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Weiss, Moy & Harris, P.C.
4204 North Brown Avenue
Scottsdale, Arizona 85251-3989

February 12th, 2004

I hereby certify that on the 12th day of February, 2004, this correspondence is being deposited with the U.S. Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, Alexandria, VA 22313-1450.

Dear Sir:

PRELIMINARY AMENDMENT

This Amendment is supplied prior to the First Office Action in order to correct the serial number and filing date of a parent application as recited on the first page of the specification.

Exhibit A

IN THE SPECIFICATION

Please Amend the first paragraph of the specification beginning on Page 1, line 9 and entitled "**CROSS-REFERENCE TO RELATED APPLICATIONS**" in accordance with the following mark-up copy:

The present application is a continuation-in-part of the following co-pending U.S. Patent applications: "IMPRINTED INTEGRATED CIRCUIT SUBSTRATE AND METHOD FOR IMPRINTING AN INTEGRATED CIRCUIT SUBSTRATE" Serial number 09/884,193 ~~09/931,144~~ filed June 19th, 2001 ~~August 16th, 2001~~; "INTEGRATED CIRCUIT SUBSTRATE HAVING LASER-EMBEDDED CONDUCTIVE PATTERNS AND METHOD THEREFOR", serial number 10/138,225 filed May 1, 2002; "SOLDERABLE INJECTION-MOLDED INTEGRATED CIRCUIT SUBSTRATE AND METHOD THEREFOR" serial number 09/931,144, filed August 16, 2001; and "INTEGRATED CIRCUIT FILM SUBSTRATE HAVING EMBEDDED CONDUCTIVE PATTERNS AND VIAS", serial number 10/261,868 filed October 1, 2002. Each of the above-listed parent applications has at least one common inventor and is assigned to the same assignee. The specifications of all of the above-listed parent applications are incorporated herein by reference.

It is not believed that this Amendment letter requires any fee, but if there are any fees incurred by this Amendment Letter, please deduct them from our Deposit Account NO. 23-0830.

Respectfully submitted,

Andrew M. Harris

Andrew M. Harris
Reg. No. 42,638
(706)-782-9683

Weiss, Moy & Harris, P.C.
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Scottsdale, AZ 85251



Exhibit B

WO 308039

Applicant Huemoeller et al.
Serial No. 10/701,782
Filed 11/05/2003
Title/Mark Integrated Circuit Substrate....

The Following has been received in the U.S.
Patent and Trademark Office on the date stamped hereon:

<input type="checkbox"/> Specification & Claims	<input type="checkbox"/> Trademark Appl. & Specimens
<input type="checkbox"/> Oath or Declaration	<input type="checkbox"/> Servicemark Appl. & Spec.
<input type="checkbox"/> Petition	<input type="checkbox"/> Declaration - Small Entity
<input type="checkbox"/> Power of Attorney	<input type="checkbox"/> Amendment Letter
<input type="checkbox"/> Transmittal Letter	<input type="checkbox"/> Certified Copy
<input type="checkbox"/> Priority Document	<input type="checkbox"/> Extension of Time
<input type="checkbox"/> Assignment	<input type="checkbox"/> Base Issue Fee Transmittal
<input type="checkbox"/> Drawings (Sheets)	<input type="checkbox"/> Design Patent Application
<input type="checkbox"/> Disclosure Statement	<input checked="" type="checkbox"/> <u>Preliminary Amend.</u>
<input type="checkbox"/> Check No. for \$	

Best Available Copy

WO 308039

Applicant Huemoeller et al.
Serial No. 10/701,782
Filed 11/05/2003
Title/Mark Integrated Circuit Substrate....

The Following has been received in the U.S.
Patent and Trademark Office on the date stamped hereon:

<input type="checkbox"/> Specification & Claims	<input type="checkbox"/> Trademark Appl. & Specimens
<input type="checkbox"/> Oath or Declaration	<input type="checkbox"/> Servicemark Appl. & Spec.
<input type="checkbox"/> Petition	<input type="checkbox"/> Declaration - Small Entity
<input type="checkbox"/> Power of Attorney	<input type="checkbox"/> Amendment Letter
<input type="checkbox"/> Transmittal Letter	<input type="checkbox"/> Certified Copy
<input type="checkbox"/> Priority Document	<input type="checkbox"/> Extension of Time
<input type="checkbox"/> Assignment	<input type="checkbox"/> Base Issue Fee Transmittal
<input type="checkbox"/> Drawings (Sheets)	<input type="checkbox"/> Design Patent Application
<input type="checkbox"/> Disclosure Statement	<input checked="" type="checkbox"/> <u>Preliminary Amend.</u>
<input type="checkbox"/> Check No. for \$	

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MAR 01 2004

